

6A, 200V - 600V Ultra Fast Surface Mount Rectifier

FEATURES

- Very low profile, typical height of 1.1mm
- Excellent high temperature stability
- Glass passivated chip junction
- Controlled avalanche characteristics
- Low leakage current
- High forward surge capability
- Moisture sensitivity level: level 1, per J-STD-020
- RoHS Compliant
- Halogen-free according to IEC 61249-2-21

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- DC to DC converter
- Switching mode converters and inverters
- Freewheeling application

MECHANICAL DATA

- Case: TO-277A (SMPC)
- Molding compound meets UL 94V-0 flammability rating
- Terminal: Matte tin plated leads, solderable per J-STD-002
- Meet JESD 201 class 1A whisker test
- · Polarity: Indicated by cathode band
- Weight: 0.095g (approximately)

KEY PARAMETERS					
PARAMETER	VALUE	TINU			
I _F	6	Α			
V_{RRM}	200 - 600	V			
I _{FSM}	80	Α			
T_{JMAX}	175	°C			
Package	TO-277A (SMPC)				
Configuration	Single die				

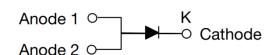








TO-277A (SMPC)



PARAMETER	SYMBOL	TPUH6D	TPUH6J	UNIT
Marking code on the device		UH6D	UH6J	
Repetitive peak reverse voltage	V_{RRM}	200	600	V
Reverse voltage, total rms value	V _{R(RMS)}	140	420	V
Forward current	I _F	(6	А
Surge peak forward current, 8.3ms single half sine wave superimposed on rated load	I _{FSM}	8	60	А
Junction temperature	T _J	-55 to +175		°C
Storage temperature	T _{STG}	-55 to +175		°C



THERMAL PERFORMANCE					
PARAMETER	SYMBOL	TYP	TINU		
Junction-to-lead thermal resistance ⁽¹⁾	$R_{\Theta JL}$	12	°C/W		
Junction-to-ambient thermal resistance ⁽²⁾	$R_{\Theta JA}$	80	°C/W		

Notes:

- 1. Mounted on FR4 PCB with 16mm x 16mm Cu pad area
- 2. Free air, mounted on recommended pad

PARAMETER		CONDITIONS	SYMBOL	TYP	MAX	UNIT
	TPUH6D	L 0A T 0500	V _F	0.80	-	V
	TPUH6J	$I_F = 3A, T_J = 25^{\circ}C$		1.98	-	V
	TPUH6D	I _F = 6A, T _J = 25°C		0.87	1.05	V
Forward voltage ⁽¹⁾	TPUH6J			2.45	3.00	V
Forward voltage	TPUH6D	I _F = 3A, T _J = 125°C		0.65	-	V
	TPUH6J			1.23	-	V
	TPUH6D	I _F = 6A, T _J = 125°C		0.73	0.90	V
	TPUH6J			1.59	1.80	V
Reverse current @ rated V _R ⁽²⁾		T _J = 25°C	I _R	-	10	μΑ
		T _J = 125°C		-	200	μΑ
Junction capacitance		1MHz, V _R = 4.0V	CJ	50	-	pF
Reverse recovery time		IF = 0.5A, IR = 1.0A Irr = 0.25A	t _{rr}	1	25	ns
		$I_F = 1A$, di/dt = -50A/ μ s $V_R = 30V$	t _{rr}	-	45	ns

Notes:

- 1. Pulse test with PW = 0.3ms
- 2. Pulse test with PW = 30ms

ORDERING INFORMATION					
ORDERING CODE ⁽¹⁾	PACKAGE	PACKING			
TPUH6x	TO-277A (SMPC)	6,000 / Tape & Reel			

Notes:

1. "x" defines voltage from 200V(TPUH6D) to 600V(TPUH6J)



CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

Fig.1 Forward Current Derating Curve

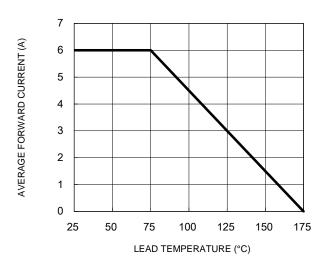


Fig.3 Typical Reverse Characteristics

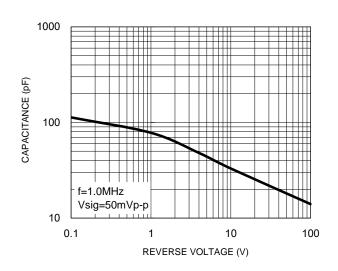
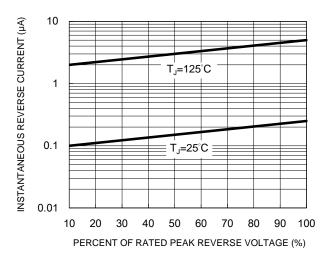


Fig.2 Typical Junction Capacitance

Fig.4 Typical Forward Characteristics



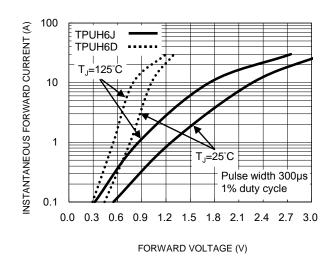
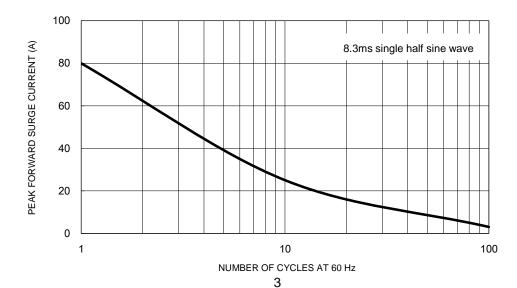


Fig.5 Maximum Non-Repetitive Forward Surge Current



Version: D2103

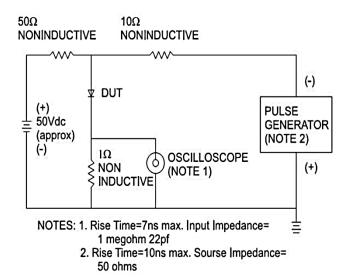
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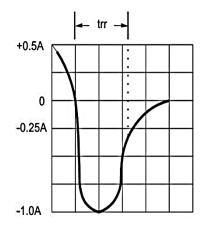


CHARACTERISTICS CURVES

 $(T_A = 25^{\circ}C \text{ unless otherwise noted})$

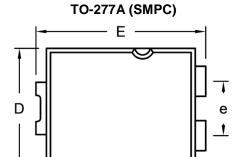
Fig.6 Reverse Recovery Time Characteristic and Test Circuit Diagram

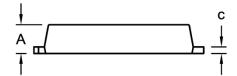




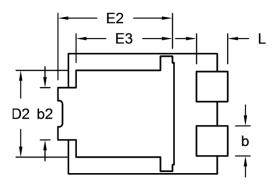


PACKAGE OUTLINE DIMENSIONS



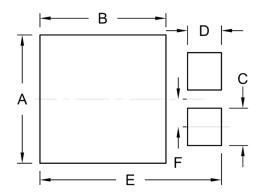


E1



DIM.	Unit (mm)		Unit (inch)	
	Min.	Max.	Min.	Max.
Α	1.000	1.200	0.039	0.047
b	1.000	1.300	0.039	0.051
b2	1.850	2.150	0.073	0.085
С	0.175	0.325	0.007	0.013
D	4.550	4.650	0.179	0.183
D2	3.170	3.470	0.125	0.137
E	6.350	6.650	0.250	0.262
E1	5.650	5.750	0.222	0.226
E2	4.235	4.535	0.167	0.179
E3	3.540	3.840	0.139	0.151
е	1.930	2.230	0.076	0.088
L	1.043	1.343	0.041	0.053

SUGGESTED PAD LAYOUT



Symbol	Unit (mm)	Unit (inch)
А	4.80	0.189
В	4.72	0.186
С	1.40	0.055
D	1.27	0.050
E	6.80	0.268
F	1.04	0.041

MARKING DIAGRAM



P/N = Marking Code YW = Date Code F = Factory Code



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